

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





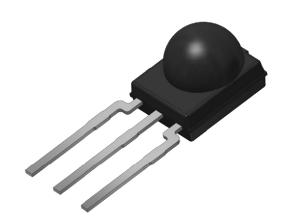




www.vishay.com

Vishay Semiconductors

IR Receiver Modules for Remote Control Systems



MECHNICAL DATA Pinning for TSOP33...:1 = OUT, 2 = GND, 3 = V_S

FEATURES

- Very low supply current
- · Photo detector and preamplifier in one package
- · Internal filter for PCM frequency
- Supply voltage: 2.5 V to 5.5 V
- · Improved immunity against ambient light
- Insensitive to supply voltage ripple and noise
- Compatible with wave or reflow soldering (see "P" version of Minimold option datasheets)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912





RoHS

FREE GREEN

DESCRIPTION

The TSOP33... series are miniaturized IR receiver modules for infrared remote control systems. A PIN diode and a preamplifier are assembled on lead frame, the epoxy package contains an IR filter.

The demodulated output signal can be directly connected to a microprocessor for decoding.

The TSOP333.. series devices are optimized to suppress almost all spurious pulses from energy saving lamps like CFLs. AGC3 may also suppress some data signals if continuously transmitted.

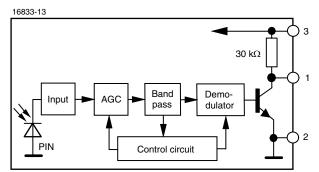
The TSOP331.. series are provided primarily for compatibility with old AGC1 designs. New designs should prefer the TSOP333.. series containing the newer AGC3. The TSOP335.. series contain a very robust AGC5. This series should only be used for critically noisy environments.

These components have not been qualified according to automotive specifications.

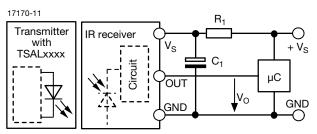
| PARTS T | ABLE | | | | | |
|-------------|--------------|---------------------------------|---|--|--|--|
| AGC | | LEGACY, FOR SHORT BURSTS (AGC1) | FOR SHORT BURSTS, NOISY ENVIRONMENTS (AGC3) | FOR SHORT BURSTS, VERY NOISY ENVIRONMENTS (AGC5) | | |
| | 30 kHz | TSOP33130 | TSOP33330 | TSOP33530 | | |
| | 33 kHz | TSOP33133 | TSOP33333 | TSOP33533 | | |
| Carrier | 36 kHz | TSOP33136 | TSOP33336 (1)(2)(7) | TSOP33536 | | |
| frequency | 38 kHz | TSOP33138 | TSOP33338 (3)(4)(5)(6) | TSOP33538 | | |
| | 40 kHz | TSOP33140 | TSOP33340 | TSOP33540 | | |
| | 56 kHz | TSOP33156 | TSOP33356 | TSOP33556 | | |
| Package | | | Minimold | | | |
| Pinning | | | 1 = OUT, 2 = GND, 3 = V _S | | | |
| Dimensions | (mm) | | 5.4 W x 6.35 H x 4.9 D | | | |
| Mounting | | | Leaded | | | |
| Application | | | Remote control | | | |
| Best remote | control code | (1) MCIR (2) RCMM (3) Mitsu | ubishi ⁽⁴⁾ RECS-80 Code ⁽⁵⁾ r-map | ⁽⁶⁾ XMP-1, XMP-2 ⁽⁷⁾ RCMM | | |



BLOCK DIAGRAM



APPLICATION CIRCUIT



 R_1 and C_1 recommended to reduce supply ripple for $V_S < 2.8 \text{ V}$

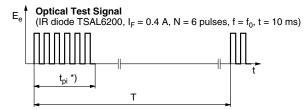
| ABSOLUTE MAXIMUM F | BSOLUTE MAXIMUM RATINGS | | | |
|-----------------------------|--------------------------|------------------|--------------------------------|------|
| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT |
| Supply voltage | | Vs | -0.3 to +6 | V |
| Supply current | | I _S | 3 | mA |
| Output voltage | | V _O | -0.3 to (V _S + 0.3) | V |
| Output current | | I _O | 5 | mA |
| Junction temperature | | T _j | 100 | °C |
| Storage temperature range | | T _{stg} | -25 to +85 | °C |
| Operating temperature range | | T _{amb} | -25 to +85 | °C |
| Power consumption | T _{amb} ≤ 85 °C | P _{tot} | 10 | mW |
| Soldering temperature | t ≤ 10 s, 1 mm from case | T _{sd} | 260 | °C |

Note

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability.

| ELECTRICAL AND OPTI | CAL CHARACTERISTICS | T _{amb} = 25 ° | C, unless o | therwise sp | pecified) | |
|-----------------------|--|-------------------------|-------------|-------------|-----------|------------------|
| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| Supply current | $E_{v} = 0, V_{S} = 3.3 V$ | I _{SD} | 0.27 | 0.35 | 0.45 | mA |
| Supply current | $E_v = 40$ klx, sunlight | I _{SH} | 1 | 0.45 | - | mA |
| Supply voltage | | V _S | 2.5 | - | 5.5 | V |
| Transmission distance | $E_v = 0$, test signal see Fig. 1, IR diode TSAL6200, $I_F = 150 \text{ mA}$ | d | - | 45 | - | m |
| Output voltage low | $I_{OSL} = 0.5 \text{ mA}, E_e = 0.7 \text{ mW/m}^2,$ test signal see Fig. 1 | V _{OSL} | - | - | 100 | mV |
| Minimum irradiance | Pulse width tolerance: t_{pi} - $5/f_0 < t_{po} < t_{pi} + 6/f_0$, test signal see Fig. 1 | E _{e min.} | - | 0.08 | 0.15 | mW/m² |
| Maximum irradiance | t_{pi} - 5/f ₀ < t_{po} < t_{pi} + 6/f ₀ , test signal see Fig. 1 | E _{e max.} | 30 | - | - | W/m ² |
| Directivity | Angle of half transmission distance | Ψ1/2 | - | ± 45 | - | deg |

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)



*) $t_{\text{ni}} \ge 6/f_0$ is recommended for optimal function

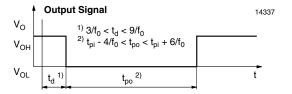


Fig. 1 - Output Active Low

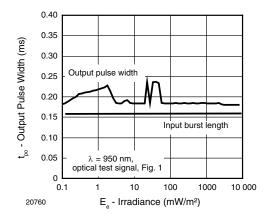


Fig. 2 - Pulse Length and Sensitivity in Dark Ambient

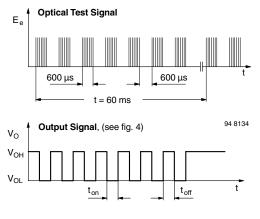


Fig. 3 - Output Function

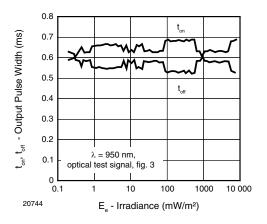


Fig. 4 - Output Pulse Diagram

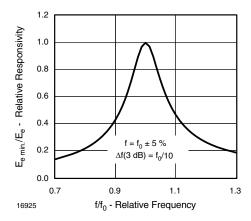


Fig. 5 - Frequency Dependence of Responsivity

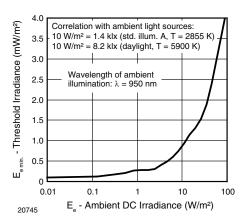


Fig. 6 - Sensitivity in Bright Ambient

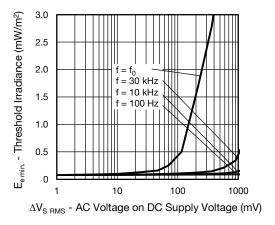


Fig. 7 - Sensitivity vs. Supply Voltage Disturbances

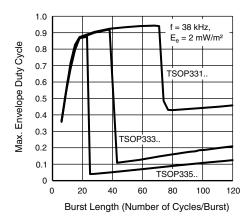


Fig. 8 - Max. Envelope Duty Cycle vs. Burst Length

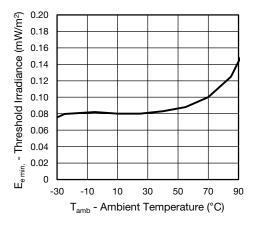


Fig. 9 - Sensitivity vs. Ambient Temperature

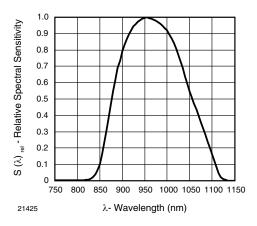


Fig. 10 - Relative Spectral Sensitivity vs. Wavelength

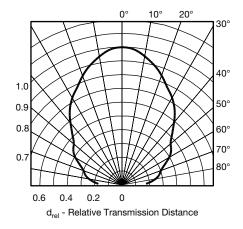


Fig. 11 - Horizontal Directivity

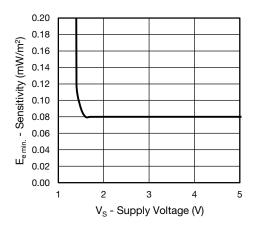


Fig. 12 - Sensitivity vs. Supply Voltage

SUITABLE DATA FORMAT

This series is designed to suppress spurious output pulses due to noise or disturbance signals. The devices can distinguish data signals from noise due to differences in frequency, burst length, and envelope duty cycle. The data signal should be close to the device's band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal presented to the device in the presence of a disturbance, the sensitivity of the receiver is automatically reduced by the AGC to insure that no spurious pulses are present at the receiver's output. Some examples which are suppressed are:

- DC light (e.g. from tungsten bulbs sunlight)
- · Continuous signals at any frequency
- Strongly or weakly modulated patterns from fluorescent lamps with electronic ballasts (see Fig. 13 or Fig. 14).

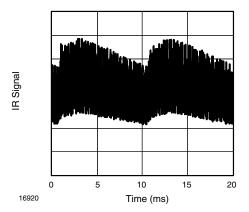


Fig. 13 - IR Disturbance from Fluorescent Lamp with Low Modulation

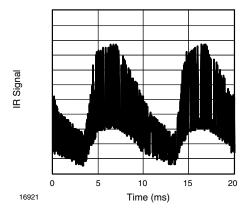


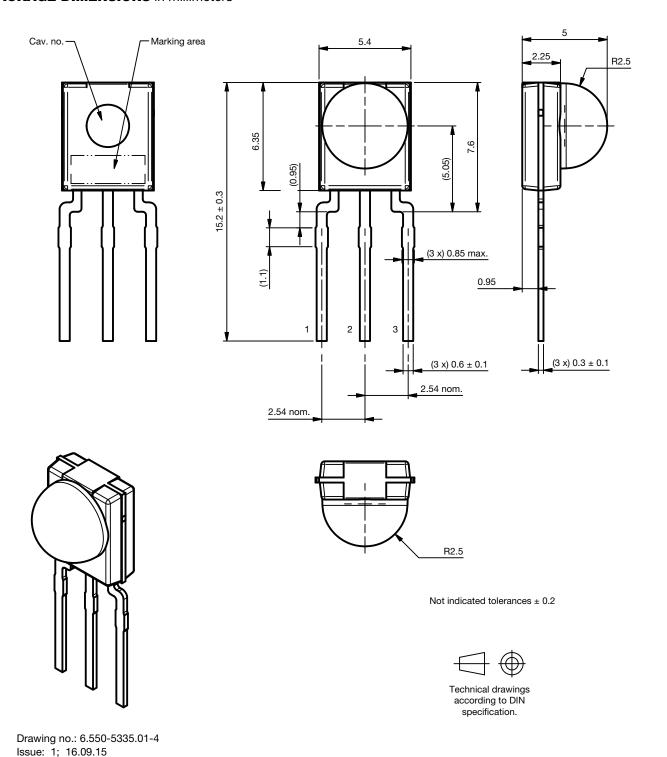
Fig. 14 - IR Disturbance from Fluorescent Lamp with High Modulation

| | TSOP331 | TSOP333 | TSOP335 |
|--|---|--|---|
| Minimum burst length | 6 cycles/burst | 6 cycles/burst | 6 cycles/burst |
| After each burst of length A gap time is required of | 6 to 70 cycles ≥ 10 cycles | 6 to 35 cycles ≥ 10 cycles | 6 to 24 cycles ≥ 10 cycles |
| For bursts greater than a minimum gap time in the data stream is needed of | 70 cycles > 1.2 x burst length | 35 cycles > 6 x burst length | 24 cycles > 25 ms |
| Maximum number of continuous short bursts/second | 2000 | 2000 | 2000 |
| MCIR code | Yes | Preferred | Yes |
| RCMM code | Yes | Preferred | Yes |
| XMP-1, XMP-2 code | Yes | Preferred | Yes |
| Suppression of interference from fluorescent lamps | Mild disturbance patterns are suppressed (example: signal pattern of Fig. 13) | Complex disturbance patterns are suppressed (example: signal pattern of Fig. 14) | Critical disturbance patterns are suppressed, e.g. highly dimmed LCDs |

Note

For data formats with long bursts (more than 10 carrier cycles) please see the datasheet for TSOP332.., TSOP334..

PACKAGE DIMENSIONS in millimeters



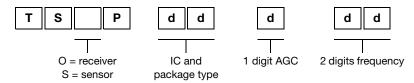
TSOP331.., TSOP333.., TSOP335..

Vishay Semiconductors

BULK PACKAGING

Standard shipping for minimold is in conductive plastic bags. The packing quantity is determined by weight and a maximum of 0.3 % of the components per carton may be missing.

ORDERING INFORMATION



Note

• d = "digit", please consult the list of available series to create a valid part number.

Examples: TSOP33338

TSOP33356VI1 TSOP33338SS1F

PACKAGING QUANTITY

- 300 pieces per bag (each bag is individually boxed).
- 6 bags per carton



Tape and Reel Standards for Surface-Mount IR Receiver Modules

Vishay Semiconductor surface-mount IR receivers are packaged on tape and reel. The following specification is based on IEC publication 286, which takes the industrial requirements for automatic insertion into account.

Absolute maximum ratings, mechanical dimensions, optical and electrical characteristics for taped devices are identical to the basic catalog types and can be found in the specifications for untaped devices.

PACKAGING

The tapes of components are available on reels. Each reel is marked with labels which contain the following information:

- Vishay
- Type
- Group
- Tape code, normally part of type name
- Production code
- Quantity

MISSING COMPONENTS

Up to 3 consecutive components may be missing if the gap is followed by at least 6 components. A maximum of 0.5 % of the components per reel quantity may be missing. At least 5 empty positions are present at the start and the end of the tape to enable tape insertion.

Tensile strength of the tape: > 15 N

NUMBER OF COMPONENTS

A. Panhead: quantity per reel:

TT, top view package, 1190 pcs

TR, side view package, 1120 pcs

B. Heimdall: quantity per reel:

TT, top view package, 2200 pcs

TR, side view package, 2300 pcs

C. Heimdall without lens: quantity per reel:

WTT, top view package, 2200 pcs

WTR, side view package, 2300 pcs

D. Belobog: quantity per reel:

TT1, top view package, 1800 pcs

TT2, top view package, 7000 pcs

E. Belobog with shield: quantity per reel:

TT1, top view package, 1500 pcs

TT2, top view package, 5000 pcs

F. Minimold DF1P: quantity per reel:

DF1P, 1100 pcs

G. TVCastSMD TR: quantity per reel:

TR, side view package, 2200 pcs

ORDER DESIGNATION

The type designation of the device is extended by TT or TT1 for top view or TR for side view.

Example:

TSOP6238TR (reel packing)

TSOP75238TR (reel packing)

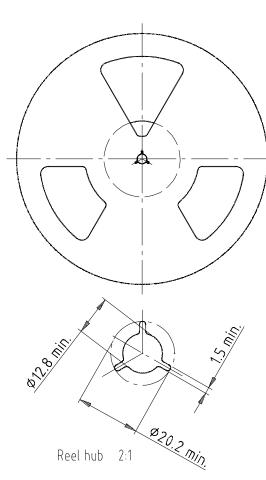
TSOP75338WTT (reel packing)

TSOP57438TT1 (reel packing)

TSOP57238HTT1 (reel packing)

TSOP39438TR (reel packing)

REEL DIMENSIONS FOR PANHEAD, HEIMDALL, AND TVCASTSMD TR in millimeters



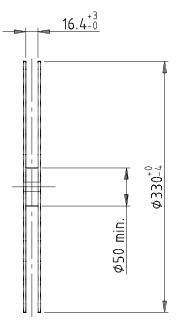
Drawing-No.: 9.800-5052.V2-4

Issue: 1; 07.05.02

16734

Note

• The body structure of the reel can vary



Form of the leave open of the wheel is supplier specific.

Dimension acc. to IEC EN 60 286-3

Tape width 16

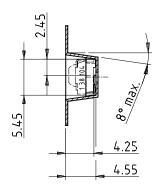


technical drawings according to DIN specifications

TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

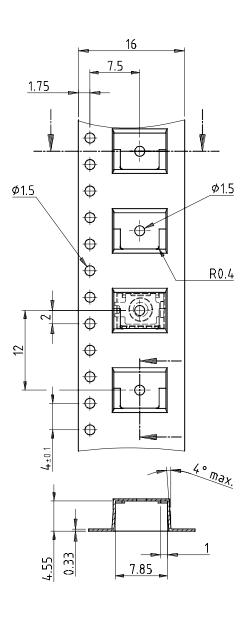
A. Panhead (TSOP36...TT, TSSP....TT, TSOP6...TT)





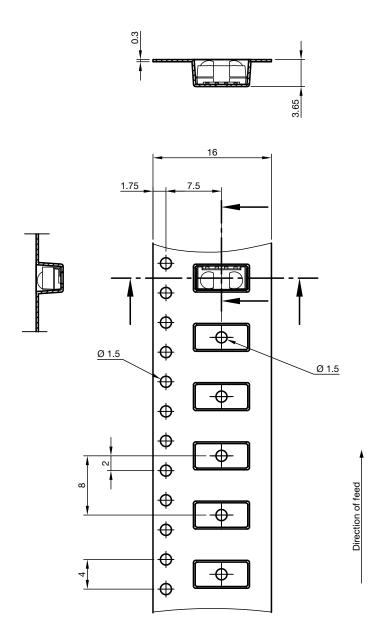
Drawing-No.: 9.700-5259.01-4 Issue: 1; 05.09.01

16584



TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

B. Heimdall (TSOP75...TT, TSOP77...TT, TSSP77...TT)



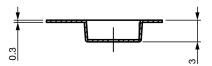
Drawing-No.: 9.700-5338.01-4

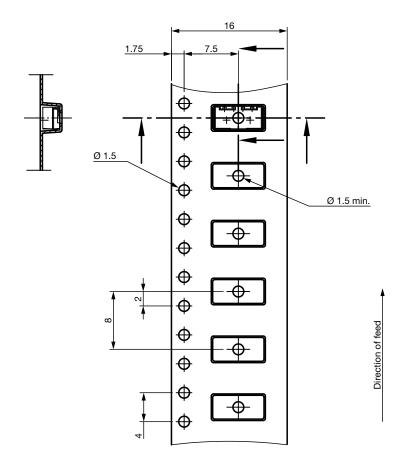
Issue: 4; 12.06.13

technical drawings according to DIN specifications

TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

C. Heimdall without lens (TSOP75...WTT, TSOP77...WTT, TSSP77...WTT)





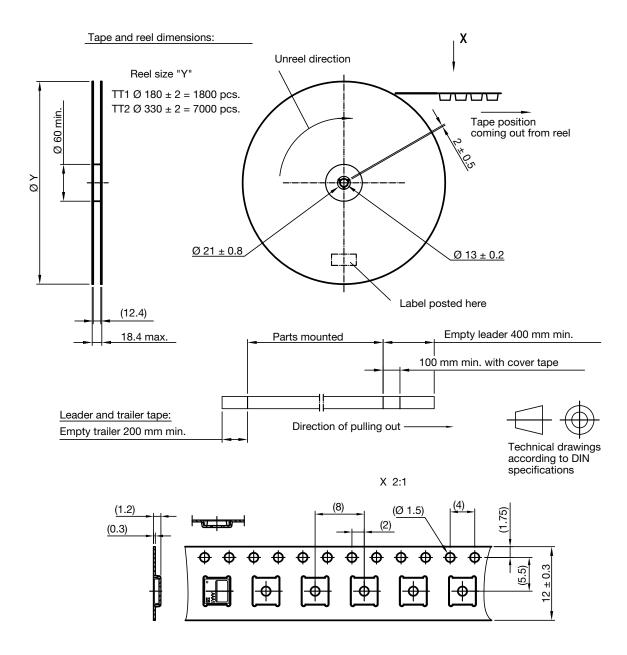
Drawing-No.: 9.700-5341.01-4

Issue: 3; 06.10.15

technical drawings according to DIN specifications

TAPING VERSION TSOP..TT1, TSOP..TT2 (TOP VIEW) DIMENSIONS in millimeters

D. Belobog (TSOP37...TT1, TSOP37...TT2, TSOP57...TT1, TSOP57...TT2)



Drawing-No.: 9.700-5347.01-4

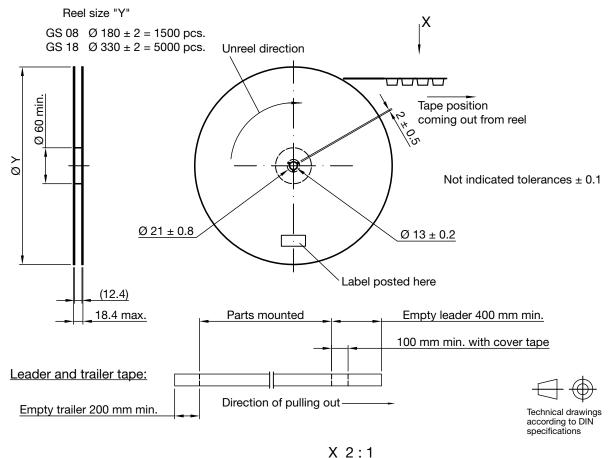
Issue: 1; 14.11.11

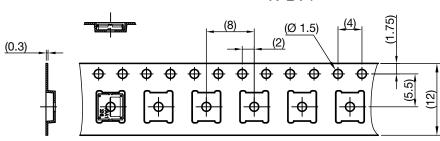
Not indicated tolerances ± 0.1

TAPING VERSION TSOP..TT1, TSOP..TT2 (TOP VIEW) DIMENSIONS in millimeters

E. Belobog with shield (TSOP37...HTT1, TSOP37...HTT2, TSOP57...HTT1, TSOP57...HTT2)

Tape and Reel dimensions:



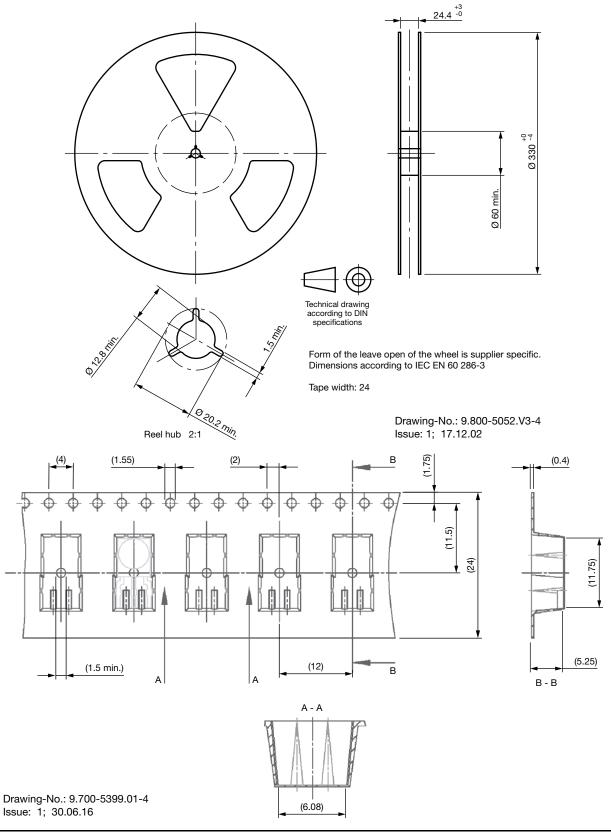


Drawing-No.: 9.700-5380.01-4

Reel dimensions and tape Issue: 1; 28.10.13

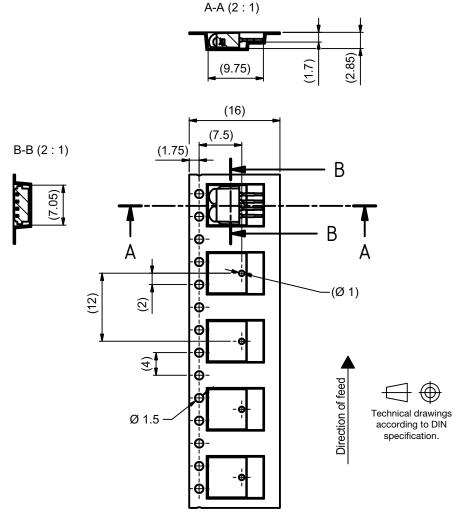
TAPING VERSION TSOP..DF1P (SIDE VIEW) DIMENSIONS in millimeters

F. Minimold DF1P (TSOP33...DF1P, TSOP53...DF1P)



TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

G. TVCastSMD TR (TSOP59...TR, TSOP39...TR)

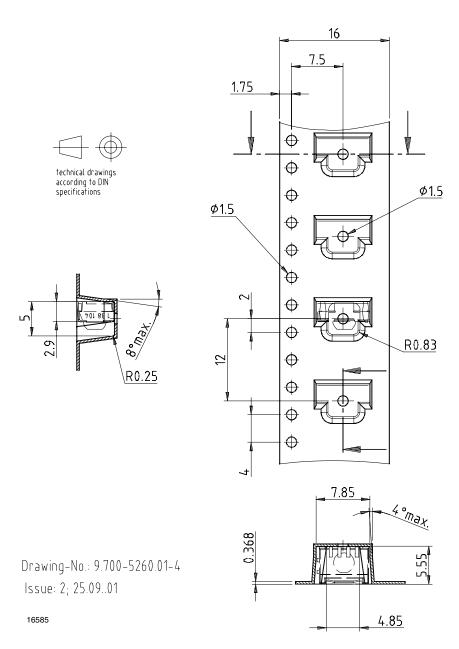


Drawing-No.: GO-100220.10_Z

Issue B: 08.02.17

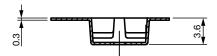
TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

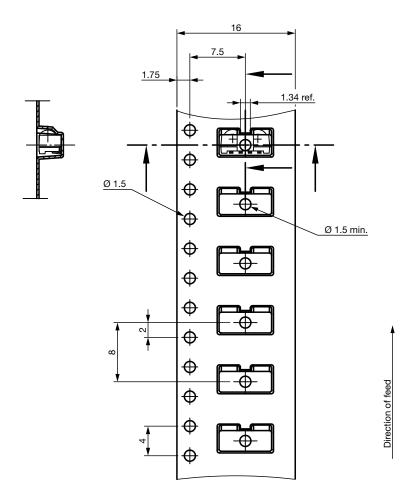
A. Panhead (TSOP36...TR, TSSP6...TR, TSOP6...TR)



TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

B. Heimdall (TSOP75..., TSOP77..., TSSP7....)





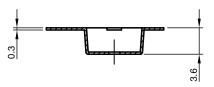
Drawing-No.: 9.700-5337.01-4

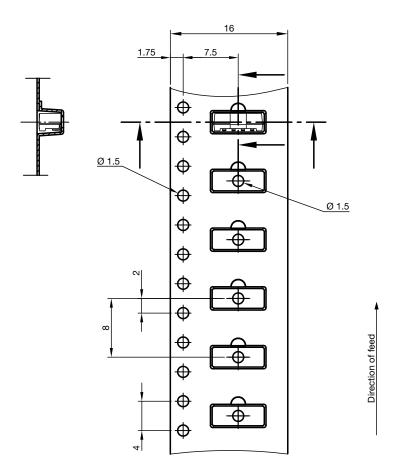
Issue: 2; 06.10.15

technical drawings according to DIN specifications

TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

C. Heimdall without lens (TSOP75...WTR, TSOP77...WTR, TSSP...WTR)





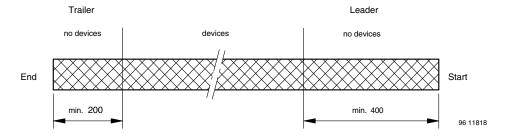
technical drawings according to DIN specifications

Drawing-No.: 9.700-5342.01-4

Issue: 2; 12.06.13



LEADER AND TRAILER DIMENSIONS in millimeters



COVER TAPE REEL STRENGTH

According to DIN EN 60286-3 0.1 N to 1.3 N 300 mm/min. \pm 10 mm/min. 165° to 180° peel angle

LABEL

Standard bar code labels for finished goods

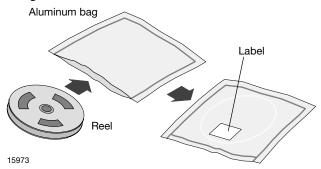
The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

| PLAIN WRITING | ABBREVIATION | LENGTH |
|----------------------|--------------|--------------|
| Item-description | - | 18 |
| Item-number | INO | 8 |
| Selection-code | SEL | 3 |
| LOT-/serial-number | BATCH | 10 |
| Data-code | COD | 3 (YWW) |
| Plant-code | PTC | 2 |
| Quantity | QTY | 8 |
| Accepted by | ACC | - |
| Packed by | PCK | - |
| Mixed code indicator | MIXED CODE | - |
| Origin | xxxxxx+ | Company logo |
| LONG BAR CODE TOP | TYPE | LENGTH |
| Item-number | N | 8 |
| Plant-code | N | 2 |
| Sequence-number | Х | 3 |
| Quantity | N | 8 |
| Total length | - | 21 |
| SHORT BAR CODE TOP | TYPE | LENGTH |
| Selection-code | Х | 3 |
| Data-code | N | 3 |
| Batch-number | X | 10 |
| Filter | - | 1 |
| Total length | - | 17 |



DRY PACKAGING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

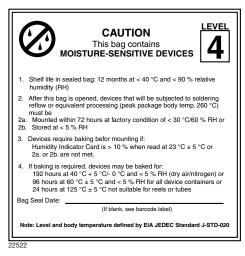
In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC $^{\!0}\!\!\!\!\!^{^{^{}}}$ standard JSTD-020 level 4 label is included on all dry bags.



EIA JEDEC standard JSTD-020 level 4 label is included on all dry bags

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

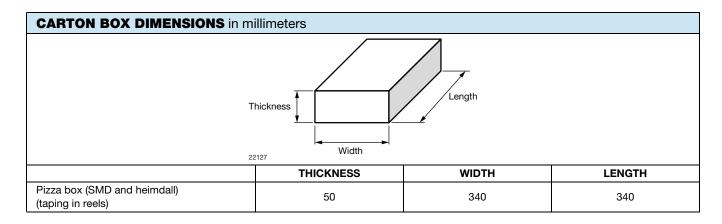
VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



OUTER PACKAGING

The sealed reel is packed into a pizza box.





Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.